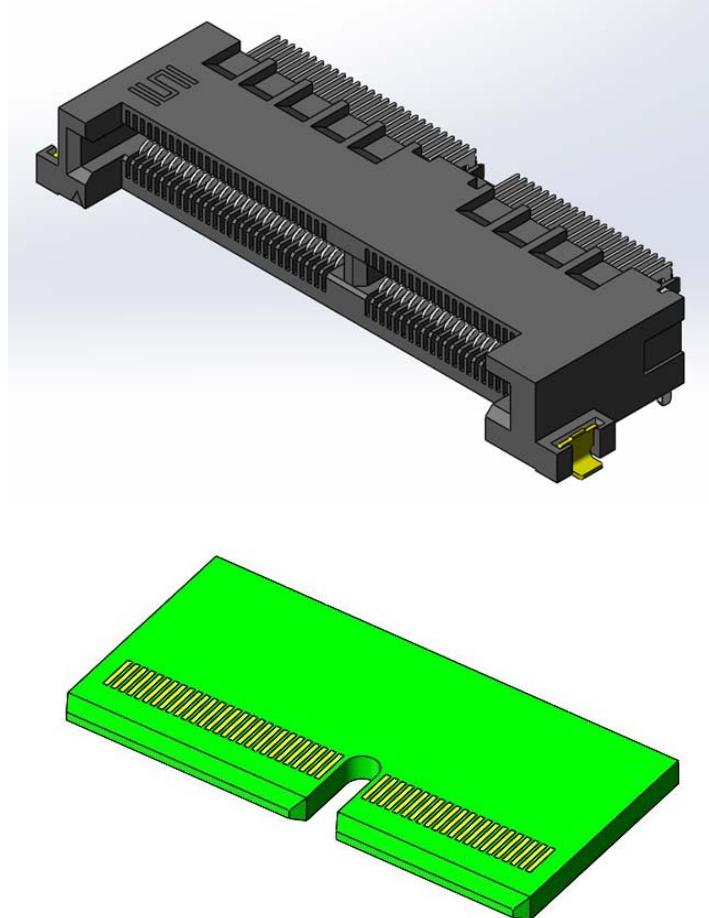




Project Number: Design Qualification Test Report	Tracking Code: 1044440_Report_Rev_1
Requested by: Leo Lee	Date: 5/16/2017
Part #: MEC5-080-01-L-RA-WT2 /EDGE CARD	
Part description: MEC5/EDGE CARD	Tech: Kason He
Test Start: 12/22/2016	Test Completed: 2/15/2017



DESIGN QUALIFICATION TEST REPORT

MEC5/EDGE CARD
MEC5-080-01-L-RA-WT2 /EDGE CARD

Tracking Code: 1044440 Report Rev 1	Part #: MEC5-080-01-L-RA-WT2 /EDGE CARD
Part description: MEC5/EDGE CARD	

REVISION HISTORY

DATA	REV.NUM.	DESCRIPTION	ENG
2/15/2017	1	Initial Issue	KH
5/16/2017	2	Add the S&V data	KH

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: EIA Publication 364

TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR and DWV/IR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR and DWV/IR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead free
- 9) Samtec Test PCBs used: PCB-107110-TST, PCB-107111-TST, PCB-107113-TST.

FLOWCHARTS**Gas Tight**Group 1

MEC5-080-01-L-RA-WT2

0.056" EDGE CARD

8 Assemblies

*Note: Connector soldered to the PCB
0.056" thickness edge card (Min)*

*C-401-XX-L***Step Description**

1. LLCR (2)
2. Gas Tight (1)
3. LLCR (2)
Max Delta = 15 mOhm

(1) Gas Tight = EIA-364-36

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max
Test Current = 100 mA Max

Normal ForceGroup 1

MEC5-080-01-L-RA-WT2

8 Contacts Minimum
Signal Without Thermals

Step Description

1. Contact Gaps
2. Normal Force (1)
Deflection = 0.018"
Expected Force at Max Deflection = 75.4 g

Group 2

MEC5-080-01-L-RA-WT2

0.068" EDGE CARD
8 Contacts Minimum
Signal With Thermals

*Note: Connector soldered to the PCB
0.068" thickness edge card (Max)*

*C-401-XX-L***Step Description**

1. Contact Gaps
2. Thermal Age (2)
3. Contact Gaps
4. Normal Force (1)
Deflection = 0.018"
Expected Force at Max Deflection = 75.4 g

(1) Normal Force = EIA-364-04

(2) Thermal Age = EIA-364-17

Test Condition = 4 (105°C)

Time Condition = B (250 Hours)

FLOWCHARTS Continued**Thermal Aging****Group 1**

MEC5-080-01-L-RA-WT2
0.056" EDGE CARD
8 Assemblies

*Note: Connector soldered to the PCB
0.056" thickness edge card (Min)*

Group 2

MEC5-080-01-L-RA-WT2
0.068" EDGE CARD
8 Assemblies

*Note: Connector soldered to the PCB
0.068" thickness edge card (Max)*

Step **Description**

1. Contact Gaps
2. Mating/Unmating Force⁽²⁾
3. LLCR⁽¹⁾
4. Thermal Age⁽³⁾
5. LLCR⁽¹⁾
Max Delta = 15 mOhm
6. Mating/Unmating Force⁽²⁾
7. Contact Gaps

Step **Description**

1. Contact Gaps
2. Mating/Unmating Force⁽²⁾
3. LLCR⁽¹⁾
4. Thermal Age⁽³⁾
5. LLCR⁽¹⁾
Max Delta = 15 mOhm
6. Mating/Unmating Force⁽²⁾
7. Contact Gaps

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max
Test Current = 100 mA Max

(2) Mating/Unmating Force = EIA-364-13

(3) Thermal Age = EIA-364-17
Test Condition = 4 (105°C)
Time Condition = B (250 Hours)

FLOWCHARTS Continued

Mating/Unmating/Durability

0.056" thickness edge card (Min)

Group 1

MEC5-080-01-L-RA-WT2
0.056" EDGE CARD
8 Assemblies

*Note: Connector soldered to the PCB
0.056" thickness edge card (Min)*

0.068" thickness edge card (Max)

Group 2

MEC5-080-01-L-RA-WT2
0.068" EDGE CARD
8 Assemblies

*Note: Connector soldered to the PCB
0.068" thickness edge card (Max)*

Step **Description**

1. Contact Gaps
2. LLCR (2)
3. Mating/Unmating Force₍₃₎
4. Cycles
Quantity = 25 Cycles
5. Mating/Unmating Force₍₃₎
6. Cycles
Quantity = 25 Cycles
7. Mating/Unmating Force₍₃₎
8. Cycles
Quantity = 25 Cycles
9. Mating/Unmating Force₍₃₎
10. Cycles
Quantity = 25 Cycles
11. Mating/Unmating Force₍₃₎
12. Contact Gaps
13. LLCR (2)
Max Delta = 15 mOhm
14. Thermal Shock₍₄₎
15. LLCR (2)
Max Delta = 15 mOhm
16. Humidity₍₁₎
17. LLCR (2)
Max Delta = 15 mOhm
18. Mating/Unmating Force₍₃₎

Step **Description**

1. Contact Gaps
2. LLCR (2)
3. Mating/Unmating Force₍₃₎
4. Cycles
Quantity = 25 Cycles
5. Mating/Unmating Force₍₃₎
6. Cycles
Quantity = 25 Cycles
7. Mating/Unmating Force₍₃₎
8. Cycles
Quantity = 25 Cycles
9. Mating/Unmating Force₍₃₎
10. Cycles
Quantity = 25 Cycles
11. Mating/Unmating Force₍₃₎
12. Contact Gaps
13. LLCR (2)
Max Delta = 15 mOhm
14. Thermal Shock₍₄₎
15. LLCR (2)
Max Delta = 15 mOhm
16. Humidity₍₁₎
17. LLCR (2)
Max Delta = 15 mOhm
18. Mating/Unmating Force₍₃₎

(1) Humidity = EIA-364-31

Test Condition = B (240 Hours)

Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)

Test Exceptions: ambient pre-condition and delete steps 7a and

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(3) Mating/Unmating Force = EIA-364-13

(4) Thermal Shock = EIA-364-32

Exposure Time at Temperature Extremes = 1/2 Hour

Method A, Test Condition = I (-55°C to +85°C)

Test Duration = A-3 (100 Cycles)

FLOWCHARTS Continued

IR/DWV

Pin-to-Pin

<u>Group 1</u>		<u>Group 2</u>		<u>Group 3</u>	
MEC5-080-01-L-RA-WT2	0.056" EDGE CARD	MEC5-080-01-L-RA-WT2	2 Assemblies	MEC5-080-01-L-RA-WT2	0.056" EDGE CARD
0.056" thickness edge card (Min)		0.056" thickness edge card (Min)		0.056" thickness edge card (Min)	
Step	Description	Step	Description	Step	Description
1.	DWV Breakdown ⁽²⁾	1.	DWV Breakdown ⁽²⁾	1.	IR ⁽⁴⁾
				2.	DWV at Test Voltage ⁽¹⁾
				3.	Thermal Shock ⁽⁵⁾
				4.	IR ⁽⁴⁾
				5.	DWV at Test Voltage ⁽¹⁾
				6.	Humidity ⁽³⁾
				7.	IR ⁽⁴⁾
				8.	DWV at Test Voltage ⁽¹⁾

Row-to-Row

<u>Group 4</u>		<u>Group 5</u>		<u>Group 6</u>	
MEC5-080-01-L-RA-WT2	0.056" EDGE CARD	MEC5-080-01-L-RA-WT2	2 Assemblies	MEC5-080-01-L-RA-WT2	0.056" EDGE CARD
0.056" thickness edge card (Min)		0.056" thickness edge card (Min)		0.056" thickness edge card (Min)	
Step	Description	Step	Description	Step	Description
1.	DWV Breakdown ⁽²⁾	1.	DWV Breakdown ⁽²⁾	1.	IR ⁽⁴⁾
				2.	DWV at Test Voltage ⁽¹⁾
				3.	Thermal Shock ⁽⁵⁾
				4.	IR ⁽⁴⁾
				5.	DWV at Test Voltage ⁽¹⁾
				6.	Humidity ⁽³⁾
				7.	IR ⁽⁴⁾
				8.	DWV at Test Voltage ⁽¹⁾

(1) DWV at Test Voltage = EIA-364-20

Test Condition = 1 (Sea Level)

DWV test voltage is equal to 75% of the lowest breakdown voltage

Test voltage applied for 60 seconds

(2) DWV Breakdown = EIA-364-20

Test Condition = 1 (Sea Level)

DWV test voltage is equal to 75% of the lowest breakdown voltage

Test voltage applied for 60 seconds

(3) Humidity = EIA-364-31

Test Condition = B (240 Hours)

Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)

Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(4) IR = EIA-364-21

Test Condition = 500 Vdc, 2 Minutes Max

(5) Thermal Shock = EIA-364-32

Exposure Time at Temperature Extremes = 1/2 Hour

Method A, Test Condition = I (-55°C to +85°C)

Test Duration = A-3 (100 Cycles)

FLOWCHARTS Continued

Current Carrying Capacity

0.056" thickness edge card (Min)

Group 1	Group 2	Group 3	Group 4
MEC5-080-01-L-RA-WT2 0.056" EDGE CARD 2 Pins Powered Signal <i>Note: Connector soldered to the PCB 0.056" thickness edge card (Min)</i>	MEC5-080-01-L-RA-WT2 0.056" EDGE CARD 4 Pins Powered Signal <i>Note: Connector soldered to the PCB 0.056" thickness edge card (Min)</i>	MEC5-080-01-L-RA-WT2 0.056" EDGE CARD 6 Pins Powered Signal <i>Note: Connector soldered to the PCB 0.056" thickness edge card (Min)</i>	MEC5-080-01-L-RA-WT2 0.056" EDGE CARD 8 Pins Powered Signal <i>Note: Connector soldered to the PCB 0.056" thickness edge card (Min)</i>
Step Description	Step Description	Step Description	Step Description
1. CCC ⁽¹⁾ Rows = 2 Number of Positions = 1	1. CCC ⁽¹⁾ Rows = 2 Number of Positions = 2	1. CCC ⁽¹⁾ Rows = 2 Number of Positions = 3	1. CCC ⁽¹⁾ Rows = 2 Number of Positions = 4

Group 5

MEC5-080-01-L-RA-WT2

0.056" EDGE CARD

160 Pins Powered

Signal

*Note: Connector soldered to the PCB
0.056" thickness edge card (Min)*

Step Description

1. CCC⁽¹⁾
Rows = 2
Number of Positions = 80

(1) CCC = EIA-364-70

Method 2, Temperature Rise Versus Current Curve

(TIN PLATING) - Tabulate calculated current at RT, 65°C, 75°C and 95°C after derating 20% and based on 105°C

(GOLD PLATING) - Tabulate calculated current at RT, 85°C, 95°C and 115°C after derating 20% and based on 125°C

FLOWCHARTS Continued

Mechanical Shock/Random Vibration/LLCR

0.056" thickness edge card (Min)

Group 1

MEC5-080-01-L-RA-WT2

0.056" EDGE CARD

8 Assemblies

Note: Connector soldered to the PCB

0.056" thickness edge card (Min)

Step Description

1. LLCR ⁽¹⁾
2. Mechanical Shock ⁽²⁾
3. Random Vibration ⁽³⁾
4. LLCR ⁽¹⁾
Max Delta = 15 mOhm

0.068" thickness edge card (Max)

Group 2

MEC5-080-01-L-RA-WT2

0.068" EDGE CARD

8 Assemblies

Note: Connector soldered to the PCB

0.068" thickness edge card (Max)

Step Description

1. LLCR ⁽¹⁾
2. Mechanical Shock ⁽²⁾
3. Random Vibration ⁽³⁾
4. LLCR ⁽¹⁾
Max Delta = 15 mOhm

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(2) Mechanical Shock = EIA-364-27

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)

Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(3) Random Vibration = EIA-364-28

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

FLOWCHARTS Continued

Mechanical Shock/Random Vibration/Event Detection

0.056" thickness edge card (Min)

Group 1

MEC5-080-01-L-RA-WT2

0.056" EDGE CARD

60 Points

Note: Connector soldered to the PCB

0.056" thickness edge card (Min)

Step Description

1. Nanosecond Event Detection
(Mechanical Shock) ⁽¹⁾
2. Nanosecond Event Detection
(Random Vibration) ⁽²⁾

(1) Nanosecond Event Detection (Mechanical Shock)

Use EIA-364-87 for Nanosecond Event Detection:
Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-27 for Mechanical Shock:
Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)
Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(2) Nanosecond Event Detection (Random Vibration)

Use EIA-364-87 for Nanosecond Event Detection:
Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-28 for Random Vibration:
Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

- 1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors.*
- 2) Test Condition 1: -55°C to +85°C
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stressing in the mated condition.

THERMAL:

- 1) EIA-364-17, *Temperature Life with or without Electrical Load Test Procedure for Electrical Connectors.*
- 2) Test Condition 4 at 105°C
- 3) Test Time Condition B for 250 hours.
- 4) All test samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

HUMIDITY:

- 1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors.*
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25°C to +65°C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

MECHANICAL SHOCK (Specified Pulse):

- 1) Reference document: EIA-364-27, *Mechanical Shock Test Procedure for Electrical Connectors*
- 2) Test Condition C
- 3) Peak Value: 100 G
- 4) Duration: 6 Milliseconds
- 5) Wave Form: Half Sine
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

VIBRATION:

- 1) Reference document: EIA-364-28, *Vibration Test Procedure for Electrical Connectors*
- 2) Test Condition V, Letter B
- 3) Power Spectral Density: 0.04 G² / Hz
- 4) G 'RMS': 7.56
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 2.0 Hours per axis (3 axis total)

NANOSECOND-EVENT DETECTION:

- 1) Reference document: EIA-364-87, *Nanosecond-Event Detection for Electrical Connectors*
- 2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

MATING/UNMATING:

- 1) Reference document: EIA-364-13, *Mating and Unmating Forces Test Procedure for Electrical Connectors.*
- 2) The full insertion position was to within 0.003" to 0.004" of the plug bottoming out in the receptacle to prevent damage to the system under test.
- 3) One of the mating parts is secured to a floating X-Y table to prevent damage during cycling.

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

LLCR:

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. $\leq +5.0$ mOhms: ----- Stable
 - b. $+5.1$ to $+10.0$ mOhms: ----- Minor
 - c. $+10.1$ to $+15.0$ mOhms: ----- Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: ----- Marginal
 - e. $+50.1$ to $+2000$ mOhms: ----- Unstable
 - f. $>+2000$ mOhms: ----- Open Failure

TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) EIA-364-70, *Temperature Rise versus Current Test Procedure for Electrical Connectors and Sockets*.
- 2) When current passes through a contact, the temperature of the contact increases as a result of I^2R (resistive) heating.
- 3) The number of contacts being investigated plays a significant part in power dissipation and therefore temperature rise.
- 4) The size of the temperature probe can affect the measured temperature.
- 5) Copper traces on PC boards will contribute to temperature rise:
 - a. Self heating (resistive)
 - b. Reduction in heat sink capacity affecting the heated contacts
- 6) A de-rating curve, usually 20%, is calculated.
- 7) Calculated de-rated currents at four temperature points are reported:
 - a. Ambient
 - b. $85^\circ C$
 - c. $95^\circ C$
 - d. $115^\circ C$
- 8) Typically, neighboring contacts (in close proximity to maximize heat build up) are energized.
- 9) The thermocouple (or temperature measuring probe) will be positioned at a location to sense the maximum temperature in the vicinity of the heat generation area.
- 10) A computer program, *TR 803.exe*, ensures accurate stability for data acquisition.
- 11) Hook-up wire cross section is larger than the cross section of any connector leads/PC board traces, jumpers, etc.
- 12) Hook-up wire length is longer than the minimum specified in the referencing standard.

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

GAS TIGHT:

To provide method for evaluating the ability of the contacting surfaces in preventing penetration of harsh vapors which might lead to oxide formation that may degrade the electrical performance of the contact system.

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. <= +5.0 mOhms: ----- Stable
 - b. +5.1 to +10.0 mOhms: ----- Minor
 - c. +10.1 to +15.0 mOhms: ----- Acceptable
 - d. +15.1 to +50.0 mOhms: ----- Marginal
 - e. +50.1 to +2000 mOhms: ----- Unstable
 - f. >+2000 mOhms: ----- Open Failure
- 4) Procedure:
 - a. Reference document: EIA-364-36, *Test Procedure for Determination of Gas-Tight Characteristics for Electrical Connectors, Sockets and/or Contact Systems*.
 - b. Test Conditions:
 - i. Class II--- Mated pairs of contacts assembled to their plastic housings.
 - ii. Reagent grade Nitric Acid shall be used of sufficient volume to saturate the test chamber
 - iii. The ratio of the volume of the test chamber to the surface area of the acid shall be 10:1.
 - iv. The chamber shall be saturated with the vapor for at least 15 minutes before samples are added.
 - v. Exposure time, 55 to 65 minutes.
 - vi. The samples shall be no closer to the chamber walls than 1 inches and no closer to the surface of the acid than 3 inches.
 - vii. The samples shall be dried after exposure for a minimum of 1 hour.
 - viii. Drying temperature 50° C
 - ix. The final LLCR shall be conducted within 1 hour after drying.

NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):

- 1) Reference document: EIA-364-04, *Normal Force Test Procedure for Electrical Connectors*.
- 2) The contacts shall be tested in the connector housing.
- 3) If necessary, a “window” shall be made in the connector body to allow a probe to engage and deflect the contact at the same attitude and distance (plus 0.05 mm [0.002”]) as would occur in actual use.
- 4) The connector housing shall be placed in a holding fixture that does not interfere with or otherwise influence the contact force or deflection.
- 5) Said holding fixture shall be mounted on a floating, adjustable, X-Y table on the base of the Dillon TC², computer controlled test stand with a deflection measurement system accuracy of 5.0 µm (0.0002”).
- 6) The nominal deflection rate shall be 5 mm (0.2”)/minute.
- 7) Unless otherwise noted a minimum of five contacts shall be tested.
- 8) The force/deflection characteristic to load and unload each contact shall be repeated five times.
- 9) The system shall utilize the TC² software in order to acquire and record the test data.
- 10) The permanent set of each contact shall be measured within the TC² software.
- 11) The acquired data shall be graphed with the deflection data on the X-axis and the force data on the Y-axis and a print out will be stored with the Tracking Code paperwork.

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes

INSULATION RESISTANCE (IR):

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-21, *Insulation Resistance Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Electrification Time 2.0 minutes
 - iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.
- 2) MEASUREMENTS:
- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-20, *Withstanding Voltage Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Barometric Test Condition 1
 - iii. Rate of Application 500 V/Sec
 - iv. Test Voltage (VAC) until breakdown occurs
- 2) MEASUREMENTS/CALCULATIONS
 - a. The breakdown voltage shall be measured and recorded.
 - b. The dielectric withstanding voltage shall be recorded as 75% of the minimum breakdown voltage.
 - c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

RESULTS

Temperature Rise, CCC at a 20% de-rating

- CCC for a 30°C Temperature Rise-----1.5 A per contact with 2 contacts (2x1) powered
- CCC for a 30°C Temperature Rise-----1.1 A per contact with 4 contacts (2x2) powered
- CCC for a 30°C Temperature Rise-----1.0 A per contact with 6 contacts (2x3) powered
- CCC for a 30°C Temperature Rise-----0.9 A per contact with 8 contacts (2x4) powered
- CCC for a 30°C Temperature Rise-----0.3 A per contact with 160 contacts (2x80) powered

Mating – Unmating Forces

Thermal Aging Group (MEC5-080-01-L-RA-WT2 /0.056" EDGE CARD)

- Initial
 - Mating
 - Min -----11.79 Lbs
 - Max-----16.14 Lbs
 - Unmating
 - Min -----4.93 Lbs
 - Max-----7.96 Lbs
- After Thermal
 - Mating
 - Min -----9.96 Lbs
 - Max-----14.31 Lbs
 - Unmating
 - Min -----5.38 Lbs
 - Max-----7.83 Lbs

Thermal Aging Group (MEC5-080-01-L-RA-WT2 /0.068" EDGE CARD)

- Initial
 - Mating
 - Min -----13.08 Lbs
 - Max-----18.50 Lbs
 - Unmating
 - Min -----4.77 Lbs
 - Max-----6.37 Lbs
- After Thermal
 - Mating
 - Min -----11.42 Lbs
 - Max-----13.98 Lbs
 - Unmating
 - Min -----4.74 Lbs
 - Max-----6.20 Lbs

RESULTS Continued

Mating – Unmating Forces

Mating-Unmating Durability Group (MEC5-080-01-L-RA-WT2 /0.056" EDGE CARD)

- Initial
 - Mating
 - Min ----- 9.35 Lbs
 - Max----- 12.22 Lbs
 - Unmating
 - Min ----- 5.80 Lbs
 - Max----- 7.59 Lbs
- After 25 Cycles
 - Mating
 - Min ----- 10.83 Lbs
 - Max----- 12.82 Lbs
 - Unmating
 - Min ----- 7.19 Lbs
 - Max----- 8.66 Lbs
- After 50 Cycles
 - Mating
 - Min ----- 11.32 Lbs
 - Max----- 13.60 Lbs
 - Unmating
 - Min ----- 7.62 Lbs
 - Max----- 8.97 Lbs
- After 75 Cycles
 - Mating
 - Min ----- 11.57 Lbs
 - Max----- 14.32 Lbs
 - Unmating
 - Min ----- 7.83 Lbs
 - Max----- 9.13 Lbs
- After 100 Cycles
 - Mating
 - Min ----- 11.86 Lbs
 - Max----- 15.24 Lbs
 - Unmating
 - Min ----- 8.12 Lbs
 - Max----- 9.31 Lbs
- Humidity
 - Mating
 - Min ----- 7.95 Lbs
 - Max----- 10.64 Lbs
 - Unmating
 - Min ----- 6.50 Lbs
 - Max----- 7.82 Lbs

RESULTS Continued

Mating-Unmating Durability Group (MEC5-080-01-L-RA-WT2 /0.068" EDGE CARD)

- Initial
 - Mating
 - Min ----- 12.27 Lbs
 - Max ----- 17.00 Lbs
 - Unmating
 - Min ----- 4.06 Lbs
 - Max ----- 5.75 Lbs
- After 25 Cycles
 - Mating
 - Min ----- 12.61 Lbs
 - Max ----- 17.71 Lbs
 - Unmating
 - Min ----- 6.08 Lbs
 - Max ----- 7.86 Lbs
- After 50 Cycles
 - Mating
 - Min ----- 12.96 Lbs
 - Max ----- 18.06 Lbs
 - Unmating
 - Min ----- 7.23 Lbs
 - Max ----- 9.02 Lbs
- After 75 Cycles
 - Mating
 - Min ----- 13.23 Lbs
 - Max ----- 18.52 Lbs
 - Unmating
 - Min ----- 8.31 Lbs
 - Max ----- 10.21 Lbs
- After 100 Cycles
 - Mating
 - Min ----- 13.26 Lbs
 - Max ----- 18.77 Lbs
 - Unmating
 - Min ----- 8.36 Lbs
 - Max ----- 11.16 Lbs
- Humidity
 - Mating
 - Min ----- 7.04 Lbs
 - Max ----- 12.21 Lbs
 - Unmating
 - Min ----- 4.78 Lbs
 - Max ----- 6.59 Lbs

RESULTS Continued

Normal Force at 0.0158 inch deflection

C-401-01-01

- Initial
 - Min-----51.70 gf Set ----- 0.0002 in
 - Max-----56.60 gf Set ----- 0.0008 in
- Thermal
 - Min-----44.70 gf Set ----- 0.0013 in
 - Max-----47.30 gf Set ----- 0.0017 in

C-401-02-01

- Initial
 - Min-----53.80 gf Set ----- 0.0000 in
 - Max-----55.50 gf Set ----- 0.0001 in
- Thermal
 - Min-----41.40 gf Set ----- 0.0010 in
 - Max-----46.00 gf Set ----- 0.0021 in

RESULTS Continued

Insulation Resistance minimums, IR

Pin to Pin

- Initial
 - Mated ----- 10000 Meg Ω ----- Passed
 - Unmated ----- 10000 Meg Ω ----- Passed
- Thermal Shock
 - Mated ----- 10000 Meg Ω ----- Passed
 - Unmated ----- 10000 Meg Ω ----- Passed
- Humidity
 - Mated ----- 10000 Meg Ω ----- Passed
 - Unmated ----- 10000 Meg Ω ----- Passed

Row to Row

- Initial
 - Mated ----- 10000 Meg Ω ----- Passed
 - Unmated ----- 10000 Meg Ω ----- Passed
- Thermal Shock
 - Mated ----- 10000 Meg Ω ----- Passed
 - Unmated ----- 10000 Meg Ω ----- Passed
- Humidity
 - Mated ----- 10000 Meg Ω ----- Passed
 - Unmated ----- 10000 Meg Ω ----- Passed

Dielectric Withstanding Voltage minimums, DWV

Minumums

- Breakdown Voltage ----- 750 VAC
- Test Voltage ----- 565 VAC
- Working Voltage ----- 185 VAC

Pin to Pin

- Initial DWV ----- Passed
- Thermal DWV ----- Passed
- Humidity DWV ----- Passed

Row to Row

- Initial DWV ----- Passed
- Thermal DWV ----- Passed
- Humidity DWV ----- Passed

RESULTS Continued

LLCR Thermal Aging Group (80 row1 and 112 row2 LLCR test points)

MEC5-080-01-L-RA-WT2 /0.056" EDGE CARD

Row1

- Initial ----- **29.06 mOhms Max**
- Thermal
 - <= +5.0 mOhms ----- 80 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Row2

- Initial ----- **33.34 mOhms Max**
- Thermal
 - <= +5.0 mOhms ----- 112 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

MEC5-080-01-L-RA-WT2 /0.068" EDGE CARD

Row1

- Initial ----- **27.63 mOhms Max**
- Thermal
 - <= +5.0 mOhms ----- 80 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Row2

- Initial ----- **32.76 mOhms Max**
- Thermal
 - <= +5.0 mOhms ----- 112 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

RESULTS Continued

LLCR Mating/Unmating Durability Group (80 row1 and 112 row2 LLCR test points) MEC5-080-01-L-RA-WT2 /0.056" EDGE CARD

Row1

- Initial ----- **29.25 mOhms Max**
- Durability, 100 Cycles
 - <= +5.0 mOhms ----- 80 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Thermal Shock
 - <= +5.0 mOhms ----- 80 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Humidity
 - <= +5.0 mOhms ----- 79 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 1 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Row2

- Initial ----- **34.76 mOhms Max**
- Durability, 100 Cycles
 - <= +5.0 mOhms ----- 111 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 1 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Thermal Shock
 - <= +5.0 mOhms ----- 112 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Humidity
 - <= +5.0 mOhms ----- 109 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 3 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

RESULTS Continued

MEC5-080-01-L-RA-WT2 /0.068" EDGE CARD

Row1

- Initial ----- **30.78 mOhms Max**
- Durability, 100 Cycles
 - <= +5.0 mOhms ----- 80 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Thermal Shock
 - <= +5.0 mOhms ----- 80 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Humidity
 - <= +5.0 mOhms ----- 73 Points ----- Stable
 - +5.1 to +10.0 mOhms----- 7 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Row2

- Initial ----- **34.10 mOhms Max**
- Durability, 100 Cycles
 - <= +5.0 mOhms ----- 112 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Thermal Shock
 - <= +5.0 mOhms ----- 112 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure
- Humidity
 - <= +5.0 mOhms ----- 105 Points ----- Stable
 - +5.1 to +10.0 mOhms----- 7 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

RESULTS Continued

LLCR Gas Tight Group (80 row1 and 112 row2 LLCR test points)

MEC5-080-01-L-RA-WT2 /0.056" EDGE CARD

Row1

- Initial ----- 27.66 mOhms Max
- Gas-Tight
 - <= +5.0 mOhms ----- 76 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 4 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Row2

- Initial ----- 34.13 mOhms Max
- Gas-Tight
 - <= +5.0 mOhms ----- 107 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 5 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

RESULTS Continued

LLCR Shock & Vibration (88 row1 and 104 row2 LLCR test points)

MEC5-080-01-L-RA-WT2 /0.056" EDGE CARD

Row1

- Initial ----- **34.71 mOhms Max**
- Shock &Vibration
 - <= +5.0 mOhms ----- 88 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Row2

- Initial ----- **34.84 mOhms Max**
- Shock &Vibration
 - <= +5.0 mOhms ----- 103 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Mechanical Shock & Random Vibration:

- Shock
 - No Damage----- Pass
 - 50 Nanoseconds----- Pass
- Vibration
 - No Damage----- Pass
 - 50 Nanoseconds----- Pass

MEC5-080-01-L-RA-WT2 /0.068" EDGE CARD

Row1

- Initial ----- **28.81 mOhms Max**
- Shock &Vibration
 - <= +5.0 mOhms ----- 88 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Row2

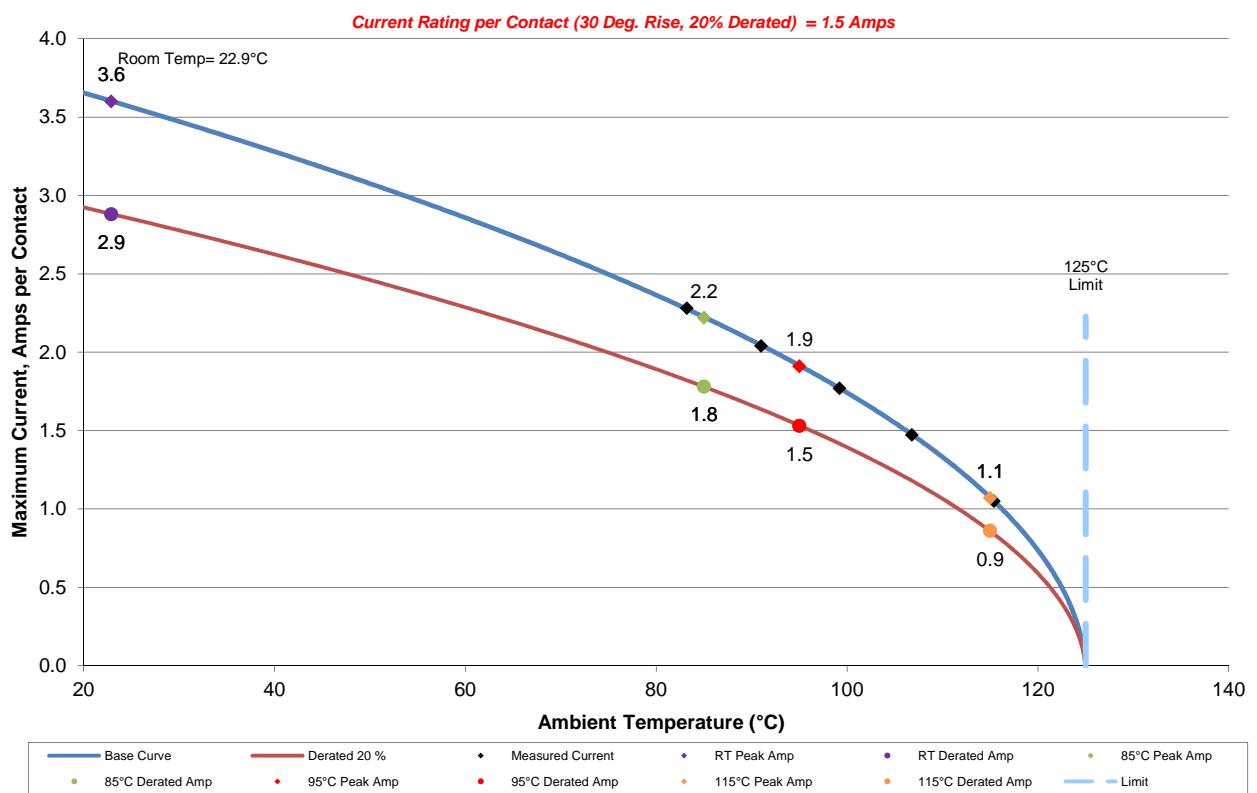
- Initial ----- **31.92 mOhms Max**
- Shock &Vibration
 - <= +5.0 mOhms ----- 104 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
 - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

DATA SUMMARIES

TEMPERATURE RISE (Current Carrying Capacity, CCC):

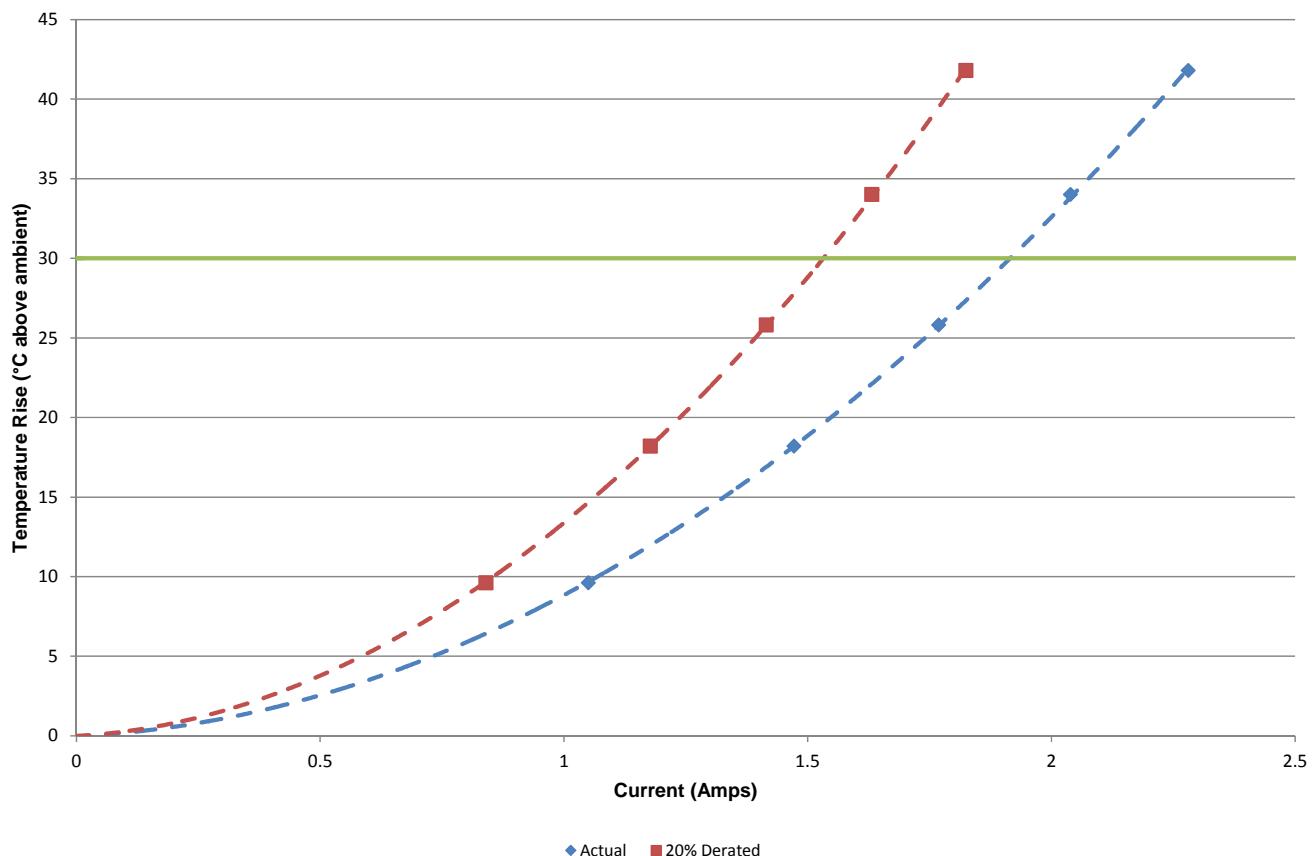
- 1) High quality thermocouples whose temperature slopes track one another were used for temperature monitoring.
- 2) The thermocouples were placed at a location to sense the maximum temperature generated during testing.
- 3) Temperature readings recorded are those for which three successive readings, 15 minutes apart, differ less than 1° C (computer controlled data acquisition).
- 4) Adjacent contacts were powered:
 - a. Linear configuration with 2 adjacent conductors/contacts powered

1044440
2(2X1) Contacts in Series
Part Numbers:MEC5-080-01-L-RA-WT2/Card 0.056"



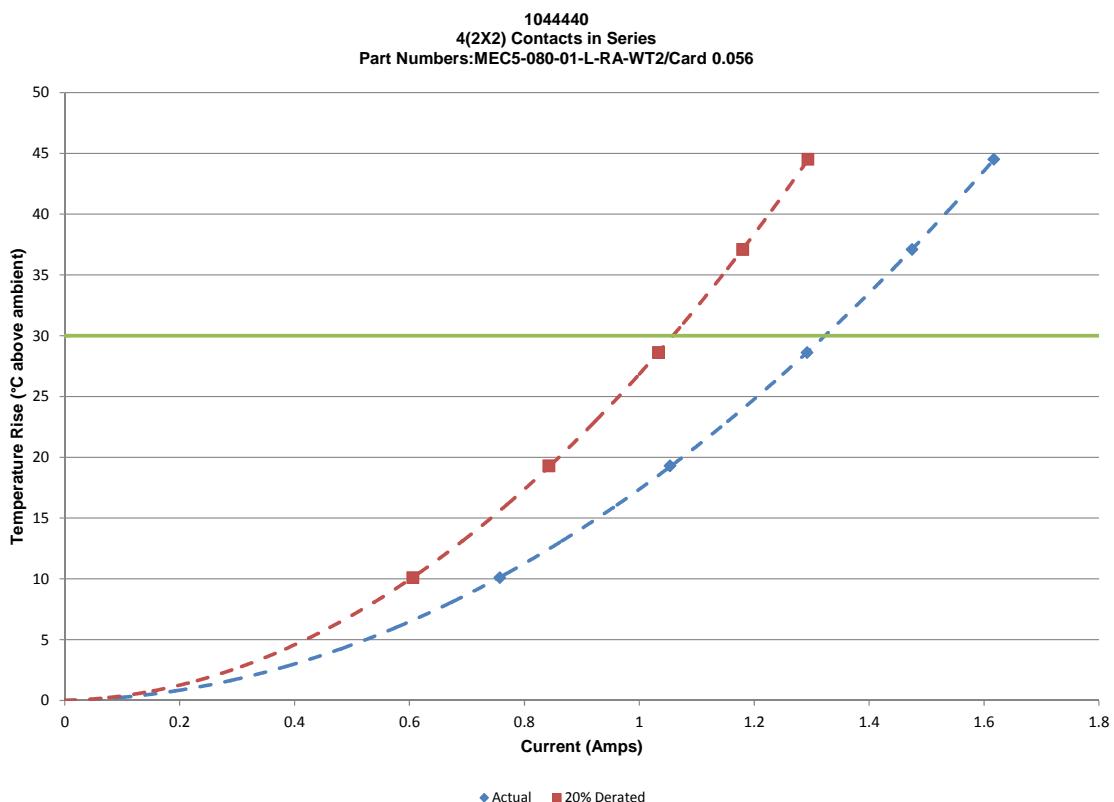
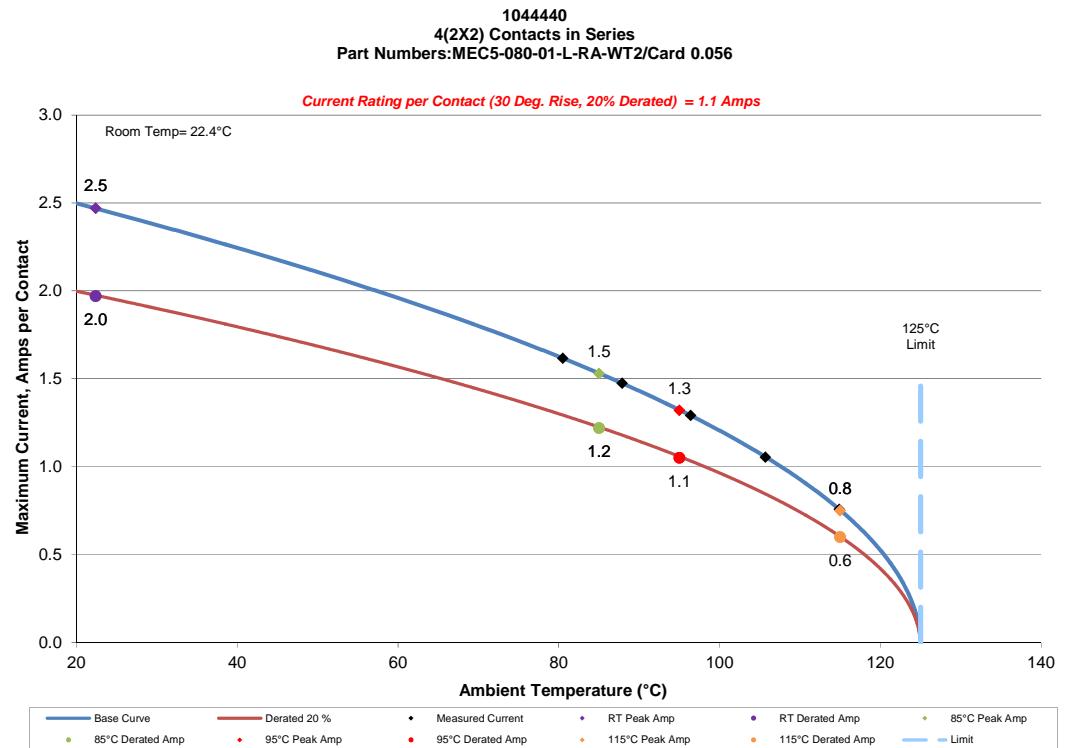
DATA SUMMARIES Continued

1044440
2(2X1) Contacts in Series
Part Numbers: MEC5-080-01-L-RA-WT2/Card 0.056"



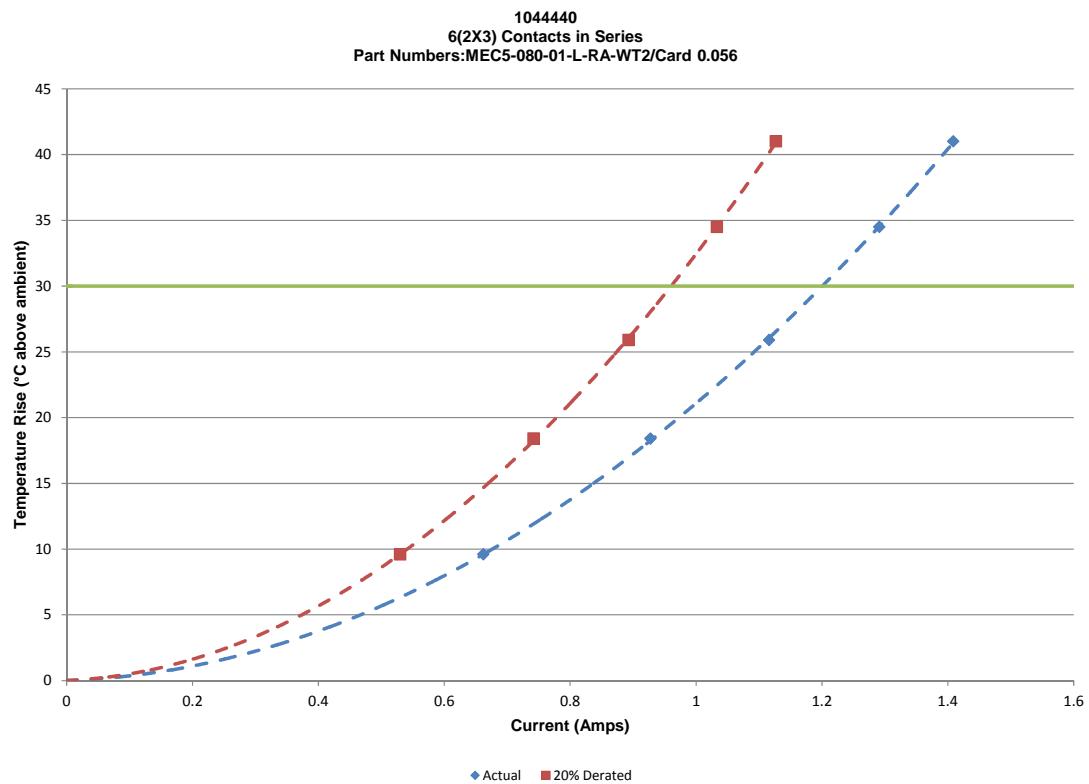
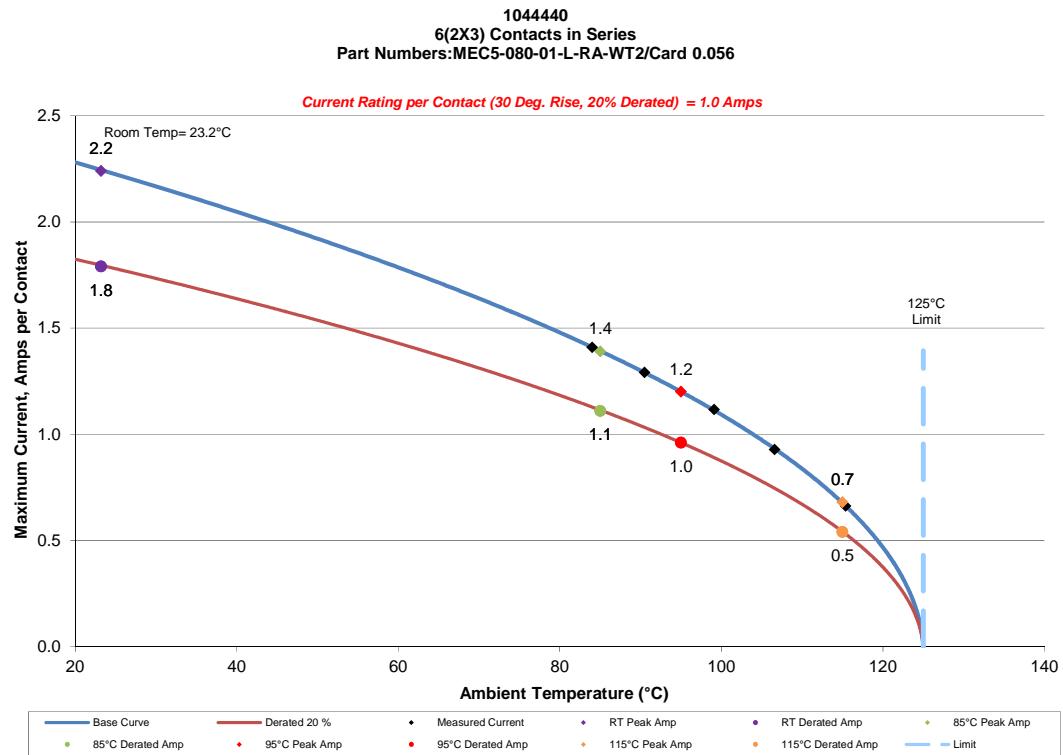
DATA SUMMARIES Continued

b. Linear configuration with 4 adjacent conductors/contacts powered



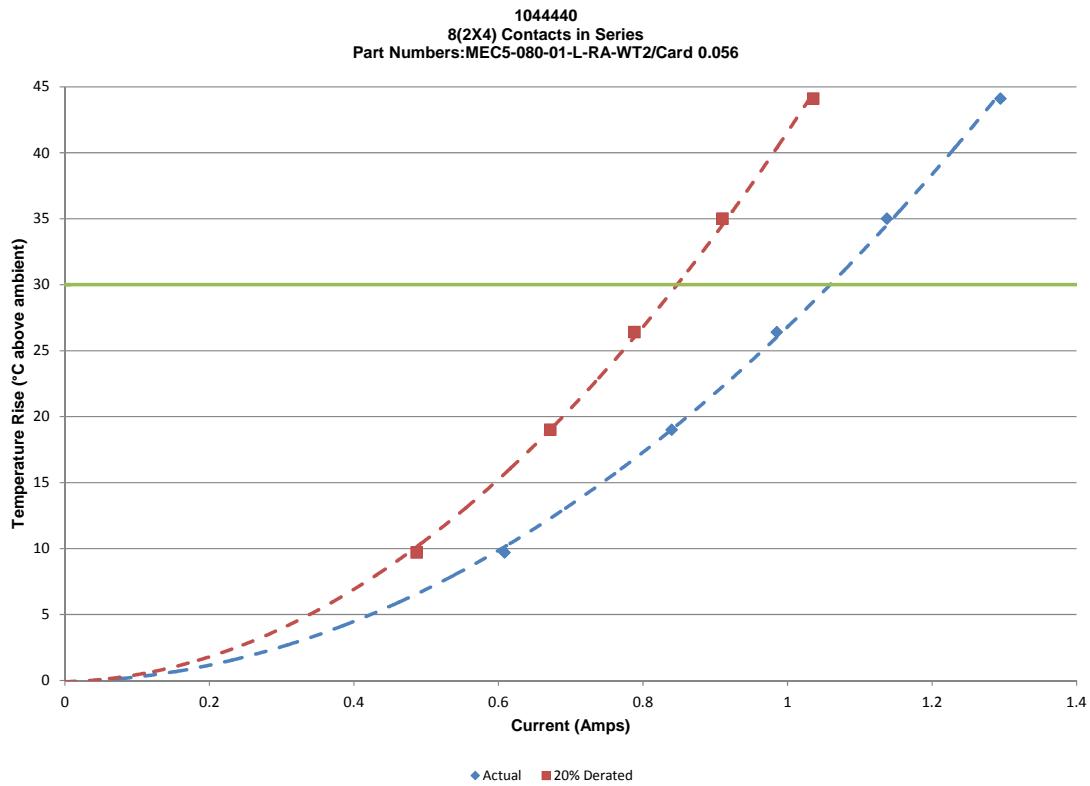
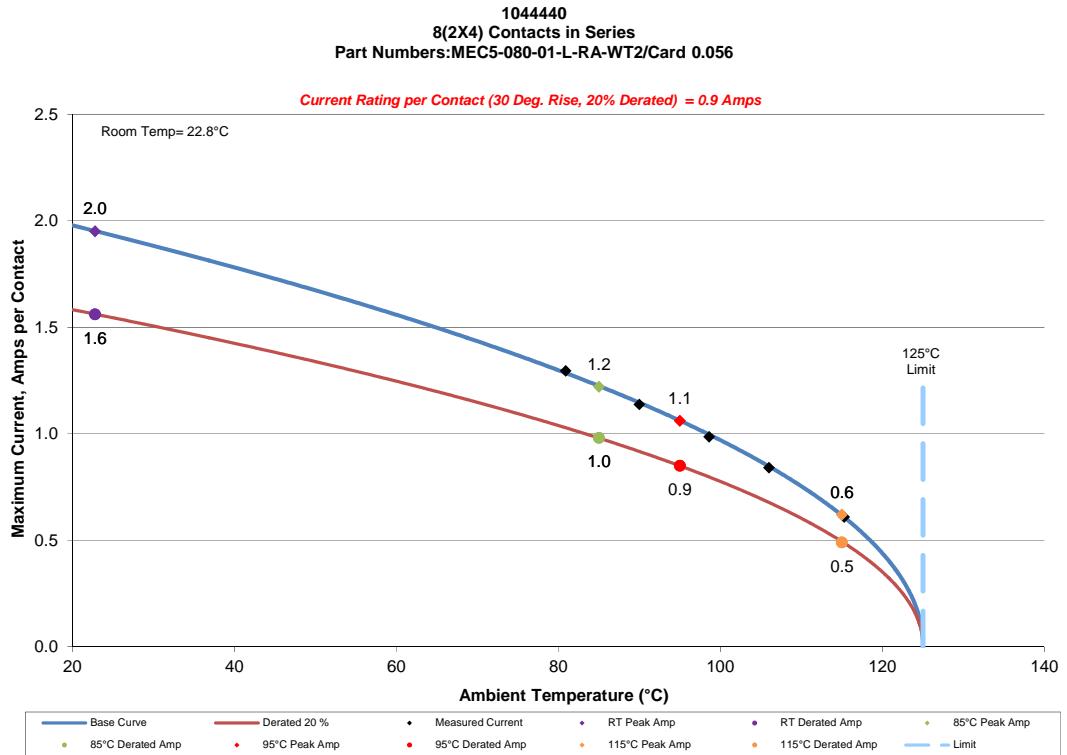
DATA SUMMARIES Continued

c. Linear configuration with 6 adjacent conductors/contacts powered



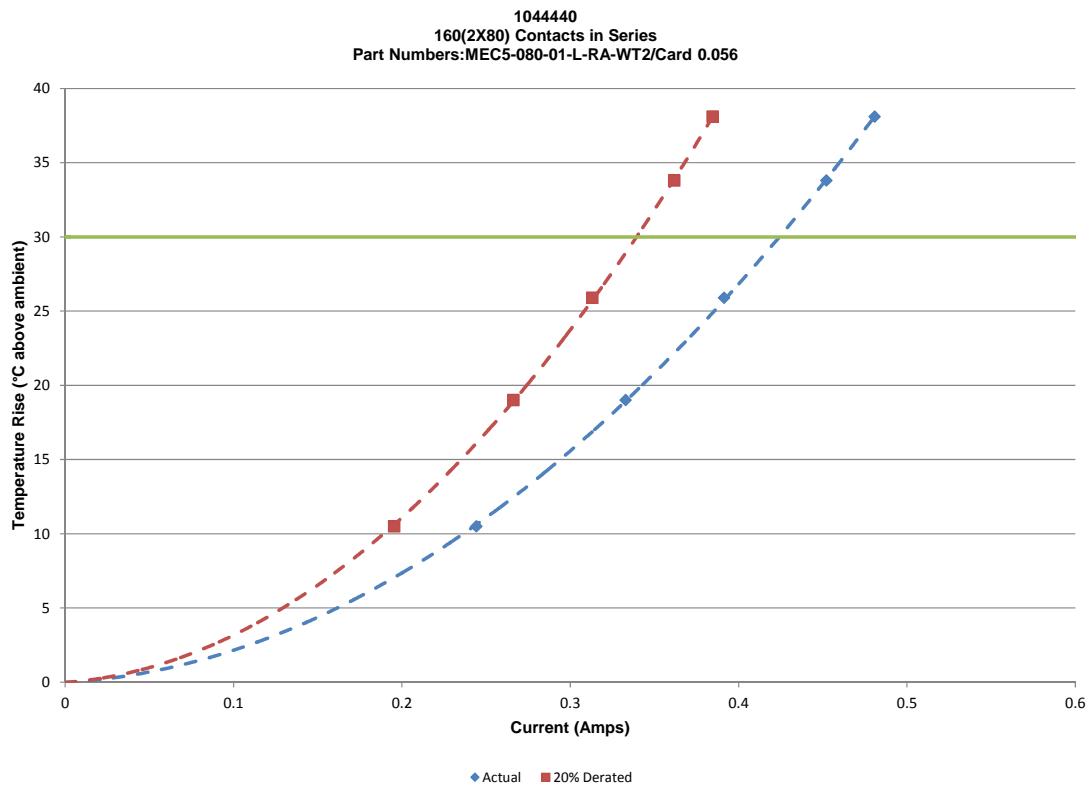
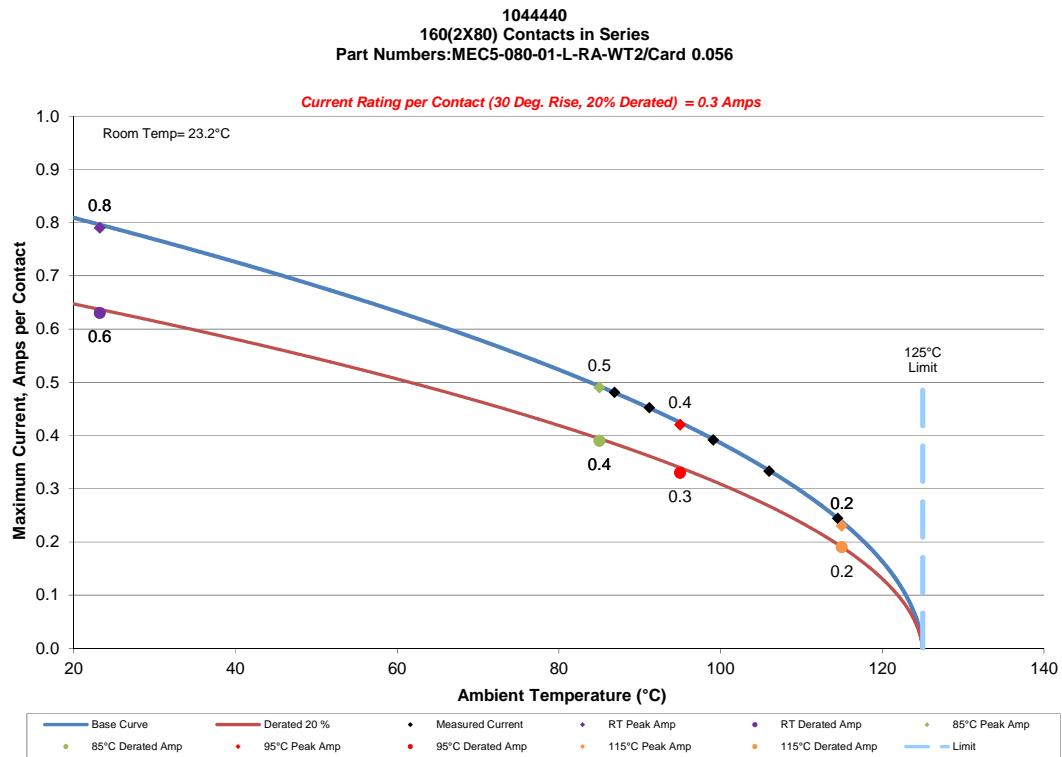
DATA SUMMARIES Continued

d. Linear configuration with 8 adjacent conductors/contacts powered



DATA SUMMARIES Continued

e. Linear configuration with all adjacent conductors/contacts powered



DATA SUMMARIES Continued

MATING-UNMATING FORCE:

Thermal Aging Group (MEC5-080-01-L-RA-WT2/0.056" EDGE CARD)

	Initial				After Thermals			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	52.44	11.79	21.93	4.93	44.30	9.96	23.80	5.35
Maximum	71.79	16.14	35.41	7.96	63.65	14.31	34.83	7.83
Average	62.21	13.99	28.14	6.33	55.27	12.43	29.69	6.68
St Dev	6.50	1.46	4.78	1.07	6.49	1.46	4.24	0.95
Count	8	8	8	8	8	8	8	8

Thermal Aging Group (MEC5-080-01-L-RA-WT2/0.068" EDGE CARD)

	Initial				After Thermals			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	58.18	13.08	21.22	4.77	50.80	11.42	21.08	4.74
Maximum	82.29	18.50	28.33	6.37	62.18	13.98	27.58	6.20
Average	67.50	15.18	24.22	5.45	57.42	12.91	24.32	5.47
St Dev	8.85	1.99	2.56	0.57	3.94	0.89	2.56	0.58
Count	8	8	8	8	8	8	8	8

DATA SUMMARIES Continued

MATING-UNMATING FORCE:

Mating-Unmating Durability Group (MEC5-080-01-L-RA-WT2/0.056" EDGE CARD)

	Initial				After 25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	41.59	9.35	25.80	5.80	48.17	10.83	31.98	7.19
Maximum	54.35	12.22	33.76	7.59	57.02	12.82	38.52	8.66
Average	47.87	10.76	29.56	6.65	52.52	11.81	34.67	7.80
St Dev	4.01	0.90	3.07	0.69	3.75	0.84	2.22	0.50
Count	8	8	8	8	8	8	8	8
After 50 Cycles				After 75 Cycles				
Mating		Unmating		Mating		Unmating		
Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	
Minimum	50.35	11.32	33.89	7.62	51.46	11.57	34.83	7.83
Maximum	60.49	13.60	39.90	8.97	63.70	14.32	40.61	9.13
Average	57.11	12.84	37.05	8.33	59.83	13.45	38.11	8.57
St Dev	3.65	0.82	2.16	0.49	4.44	1.00	2.10	0.47
Count	8	8	8	8	8	8	8	8
After 100 Cycles				After Humidity				
Mating		Unmating		Mating		Unmating		
Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	
Minimum	52.75	11.86	36.12	8.12	35.36	7.95	28.91	6.50
Maximum	67.79	15.24	41.41	9.31	47.33	10.64	34.78	7.82
Average	62.48	14.05	38.65	8.69	42.22	9.49	31.26	7.03
St Dev	5.19	1.17	2.01	0.45	4.02	0.90	1.99	0.45
Count	8	8	8	8	8	8	8	8

DATA SUMMARIES Continued

Mating-Unmating Durability Group (MEC5-080-01-L-RA-WT2/0.068" EDGE CARD)

	Initial				After 25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	54.58	12.27	18.06	4.06	56.09	12.61	27.04	6.08
Maximum	75.62	17.00	25.58	5.75	78.77	17.71	34.96	7.86
Average	68.12	15.32	23.61	5.31	71.55	16.09	31.07	6.99
St Dev	7.05	1.58	2.53	0.57	7.30	1.64	2.84	0.64
Count	8	8	8	8	8	8	8	8
After 50 Cycles				After 75 Cycles				
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
	57.65	12.96	32.16	7.23	58.85	13.23	36.96	8.31
Minimum	80.33	18.06	40.12	9.02	82.38	18.52	45.41	10.21
Average	72.86	16.38	37.49	8.43	73.94	16.62	42.31	9.51
St Dev	7.56	1.70	3.06	0.69	7.74	1.74	3.21	0.72
Count	8	8	8	8	8	8	8	8
After 100 Cycles				After Humidity				
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
	58.98	13.26	37.19	8.36	31.31	7.04	21.26	4.78
Minimum	83.49	18.77	49.64	11.16	54.31	12.21	29.31	6.59
Average	74.14	16.67	44.50	10.01	46.48	10.45	25.79	5.80
St Dev	8.16	1.84	4.13	0.93	6.88	1.55	2.80	0.63
Count	8	8	8	8	8	8	8	8

DATA SUMMARIES Continued

NORMAL FORCE (FOR CONTACTS TESTED OUT THE HOUSING):

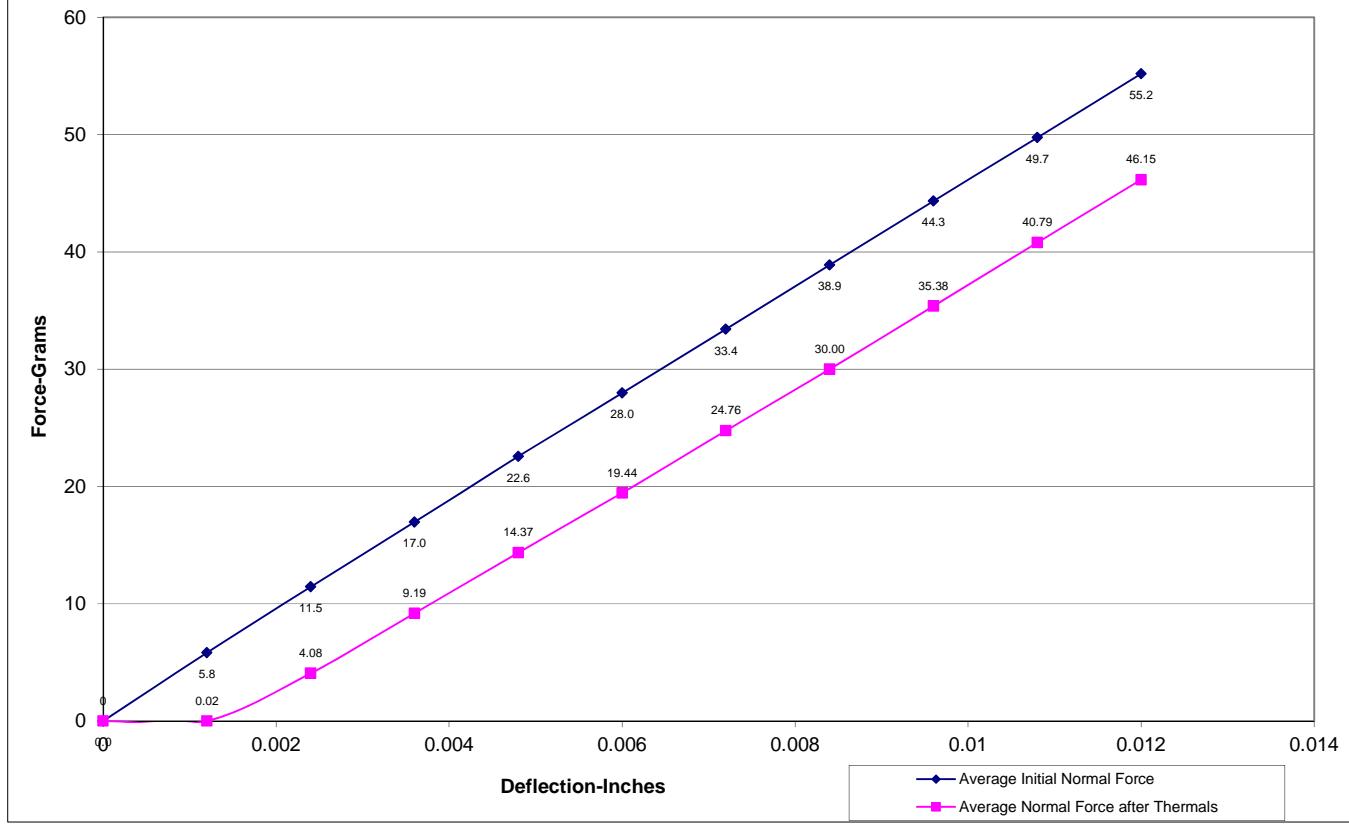
- 1) Calibrated force gauges are used along with computer controlled positioning equipment.
- 2) For Normal force 8-10 measurements are taken and the averages reported.

C-401-01-01

Initial	Deflections in inches Forces in Grams										
	0.0012	0.0024	0.0036	0.0048	0.0060	0.0072	0.0084	0.0096	0.0108	0.0120	SET
Averages	5.83	11.45	16.96	22.57	27.97	33.40	38.88	44.34	49.74	55.18	0.0000
Min	4.70	9.90	15.10	20.50	25.60	30.80	36.30	41.20	46.80	51.70	0.0002
Max	6.50	12.50	18.10	23.90	29.10	34.60	40.00	46.00	51.00	56.60	0.0008
St. Dev	0.605	0.751	0.821	0.877	0.929	1.051	1.042	1.247	1.242	1.408	0.0003
Count	12	12	12	12	12	12	12	12	12	12	12

After Thermals	Deflections in inches Forces in Grams										
	0.0012	0.0024	0.0036	0.0048	0.0060	0.0072	0.0084	0.0096	0.0108	0.0120	SET
Averages	0.02	4.08	9.19	14.37	19.44	24.76	30.00	35.38	40.79	46.15	0.0015
Min	-0.10	3.50	8.30	13.60	18.50	24.20	29.20	34.60	39.80	44.70	0.0013
Max	0.10	5.00	10.30	15.40	20.50	26.00	31.00	36.10	41.90	47.30	0.0017
St. Dev	0.094	0.456	0.592	0.521	0.476	0.504	0.538	0.496	0.642	0.753	0.0001
Count	12	12	12	12	12	12	12	12	12	12	12

Normal Force - Average Initial vs Average Thermal



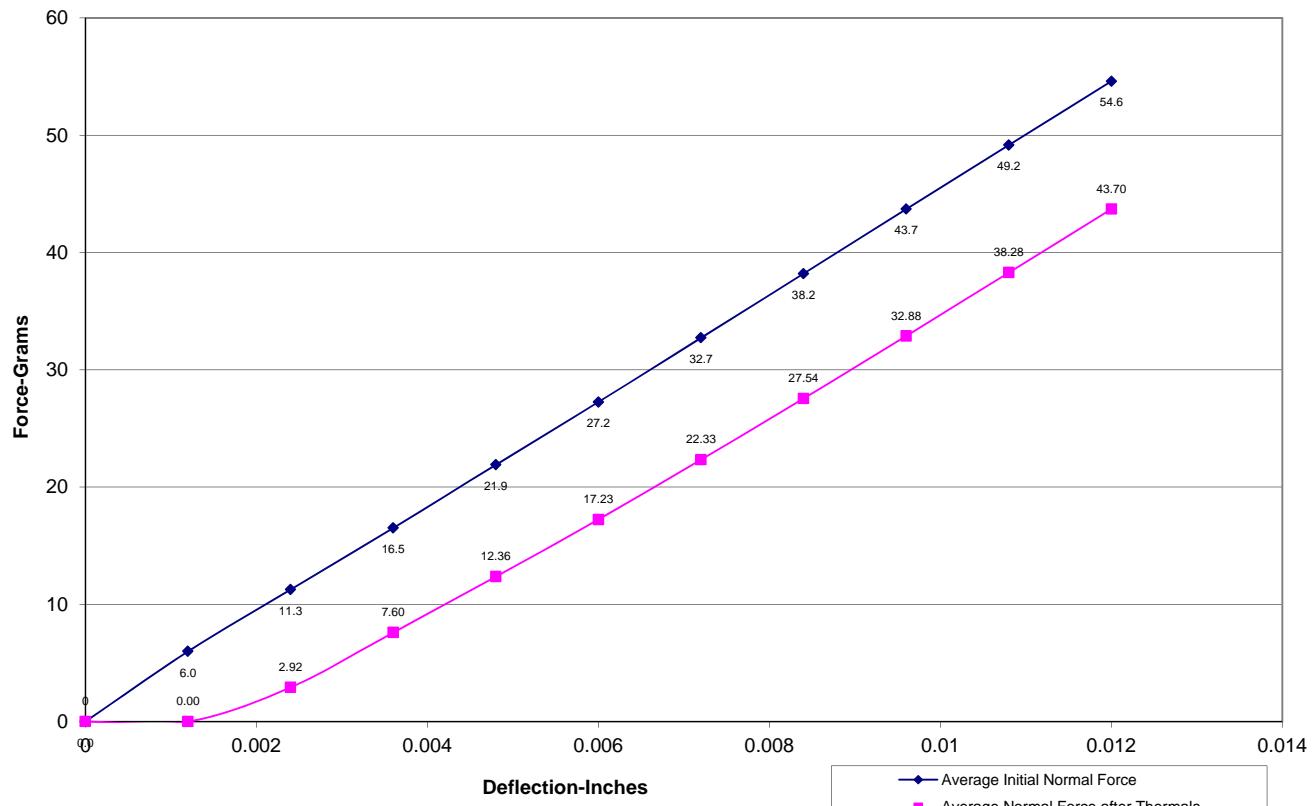
DATA SUMMARIES Continued

C-401-02-01

Initial	Deflections in inches Forces in Grams										
	0.0012	0.0024	0.0036	0.0048	0.0060	0.0072	0.0084	0.0096	0.0108	0.0120	SET
Averages	5.98	11.26	16.51	21.90	27.24	32.73	38.19	43.70	49.16	54.60	0.0001
Min	5.50	10.80	15.90	21.20	26.40	31.80	37.30	42.60	48.30	53.80	0.0000
Max	6.70	11.90	17.40	22.70	28.30	33.60	39.00	44.60	50.10	55.50	0.0001
St. Dev	0.361	0.375	0.438	0.546	0.630	0.643	0.626	0.625	0.588	0.594	0.0001
Count	12	12	12	12	12	12	12	12	12	12	12

After Thermals	Deflections in inches Forces in Grams										
	0.0012	0.0024	0.0036	0.0048	0.0060	0.0072	0.0084	0.0096	0.0108	0.0120	SET
Averages	0.00	2.92	7.60	12.36	17.23	22.33	27.54	32.88	38.28	43.70	0.0015
Min	-0.10	2.00	6.60	11.20	16.20	21.10	25.90	30.80	35.80	41.40	0.0010
Max	0.20	4.20	8.80	13.60	18.70	23.80	29.20	34.70	40.50	46.00	0.0021
St. Dev	0.113	0.718	0.766	0.904	0.916	0.953	1.003	1.111	1.362	1.346	0.0003
Count	12	12	12	12	12	12	12	12	12	12	12

Normal Force - Average Initial vs Average Thermal



DATA SUMMARIES Continued

INSULATION RESISTANCE (IR):

	Pin to Pin		
	Mated	Unmated	Unmated
Minimum	MEC5/Card	MEC5	Card
Initial	10000	10000	Not Tested
Thermal	10000	10000	Not Tested
Humidity	10000	10000	Not Tested

	Row to Row		
	Mated	Unmated	Unmated
Minimum	MEC5/Card	MEC5	Card
Initial	10000	10000	Not Tested
Thermal	10000	10000	Not Tested
Humidity	10000	10000	Not Tested

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

Voltage Rating Summary	
Minimum	MEC5/Card
Break Down Voltage	750
Test Voltage	565
Working Voltage	185

Pin to Pin	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

Row to Row	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

DATA SUMMARIES Continued

LLCR Thermal Aging Group

- 1) A total of 80 row1 and 112 row2 points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms: -----Stable
 - b. $+5.1$ to $+10.0$ mOhms: -----Minor
 - c. $+10.1$ to $+15.0$ mOhms: -----Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: -----Marginal
 - e. $+50.1$ to $+2000$ mOhms: -----Unstable
 - f. $>+2000$ mOhms: -----Open Failure

MEC5-080-01-L-RA-WT2/0.056"EDGE CARD

LLCR Measurement Summaries by Pin Type						
mOhm values	Date	12/22/2016	1/10/2017			
	Room Temp (Deg C)	23	23			
	Rel Humidity (%)	60	56			
	Technician	Kason He	Kason He			
	Actual	Delta	Delta	Delta		
	Initial	Thermal				
	Pin Type 1: Row 1					
	Average	26.40	0.55			
	St. Dev.	0.74	0.36			
	Min	24.99	0.01			
	Max	29.06	1.49			
	Summary Count	88	88			
	Total Count	88	88			
Pin Type 2: Row 2						
Average	31.31	0.55				
St. Dev.	0.59	0.58				
Min	30.07	0.01				
Max	33.34	3.93				
Summary Count	104	104				
Total Count	104	104				

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	≤ 5	$>5 \text{ & } \leq 10$	$>10 \text{ & } \leq 15$	$>15 \text{ & } \leq 50$	$>50 \text{ & } \leq 1000$	>1000
Thermal	192	0	0	0	0	0

DATA SUMMARIES Continued

MEC5-080-01-L-RA-WT2/0.068"EDGE CARD

		LLCR Measurement Summaries by Pin Type			
mOhm values	Date	12/22/2016	1/10/2017		
	Room Temp (Deg C)	23	22		
	Rel Humidity (%)	60	56		
	Technician	Kason He	Kason He		
	Actual Initial		Delta Thermal	Delta	Delta
	Pin Type 1: Row 1				
	Average	26.03	0.79		
	St. Dev.	0.51	0.72		
	Min	25.19	0.05		
	Max	27.63	3.92		
	Summary Count	88	88		
	Total Count	88	88		
Pin Type 2: Row 2					
Average	30.74	0.62			
St. Dev.	0.45	0.55			
Min	30.00	0.00			
Max	32.76	3.23			
Summary Count	104	104			
Total Count	104	104			

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Thermal	192	0	0	0	0	0

DATA SUMMARIES Continued

LLCR Mating/Unmating Durability Group

- 1). A total of 80 row1 and 112 row2 points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3). A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms: -----Stable
 - b. $+5.1$ to $+10.0$ mOhms: -----Minor
 - c. $+10.1$ to $+15.0$ mOhms: -----Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: -----Marginal
 - e. $+50.1$ to $+2000$ mOhms: -----Unstable
 - f. $> +2000$ mOhms: -----Open Failure

MEC5-080-01-L-RA-WT2/0.068"EDGE CARD

		LLCR Measurement Summaries by Pin Type			
		12/22/2016	12/28/2016	1/4/2017	1/18/2017
Date	Room Temp (Deg C)	23	20	23	20
	Rel Humidity (%)	60	43	58	60
	Technician	Kason He	Kason He	Kason He	Kason He
mOhm values	Actual	Delta	Delta	Delta	
	Initial	100 Cycles	Therm Shck	Humidity	
Pin Type 1: Row 1					
Average	26.68	0.69	0.83	1.31	
St. Dev.	0.82	0.55	0.57	1.25	
Min	25.05	0.00	0.02	0.00	
Max	29.25	2.22	2.59	7.26	
Summary Count	88	88	88	88	
Total Count	88	88	88	88	
Pin Type 2: Row 2					
Average	31.78	0.91	0.93	1.59	
St. Dev.	0.83	1.03	0.96	1.48	
Min	30.21	0.01	0.01	0.02	
Max	34.76	7.12	4.42	8.80	
Summary Count	104	104	104	104	
Total Count	104	104	104	104	

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	≤ 5	$>5 \text{ & } \leq 10$	$>10 \text{ & } \leq 15$	$>15 \text{ & } \leq 50$	$>50 \text{ & } \leq 1000$	>1000
100 Cycles	191	1	0	0	0	0
Therm Shck	192	0	0	0	0	0
Humidity	188	4	0	0	0	0

DATA SUMMARIES Continued

MEC5-080-01-L-RA-WT2/0.068"EDGE CARD

		LLCR Measurement Summaries by Pin Type			
		12/22/2016	12/28/2016	1/4/2017	1/18/2017
Date		23	20	23	20
Room Temp (Deg C)		60	43	58	60
Rel Humidity (%)		Kason He	Kason He	Kason He	Kason He
Technician		Actual Initial	Delta 100 Cycles	Delta Therm Shck	Delta Humidity
mOhm values					
Pin Type 1: Row 1					
Average		26.80	0.95	0.93	1.68
St. Dev.		1.12	0.82	0.86	1.88
Min		25.20	0.01	0.00	0.05
Max		30.78	3.33	4.04	9.10
Summary Count		88	88	88	88
Total Count		88	88	88	88
Pin Type 2: Row 2					
Average		30.99	0.72	0.61	1.47
St. Dev.		0.71	0.53	0.51	1.94
Min		29.84	0.03	0.01	0.01
Max		34.10	3.17	2.81	9.75
Summary Count		104	104	104	104
Total Count		104	104	104	104

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
100 Cycles	192	0	0	0	0	0
Therm Shck	192	0	0	0	0	0
Humidity	178	14	0	0	0	0

DATA SUMMARIES Continued

LLCR Gas Tight Group

- 1) A total of 80 row1 and 112 row2 points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms:-----Stable
 - b. $+5.1$ to $+10.0$ mOhms:-----Minor
 - c. $+10.1$ to $+15.0$ mOhms:-----Acceptable
 - d. $+15.1$ to $+50.0$ mOhms:-----Marginal
 - e. $+50.1$ to $+2000$ mOhms:-----Unstable
 - f. $>+2000$ mOhms:-----Open Failure

MEC5-080-01-L-RA-WT2/0.056"EDGE CARD

LLCR Measurement Summaries by Pin Type						
Date	1/16/2017	2/15/2017				
Room Temp (Deg C)	20	21				
Rel Humidity (%)	57	60				
Technician	Kason He	Kason He				
mOhm values	Actual Initial	Delta Acid Vapor	Delta	Delta		
Pin Type 1: Row 1						
Average	25.97	1.42				
St. Dev.	0.69	1.88				
Min	24.34	0.00				
Max	27.66	9.50				
Summary Count	80	80				
Total Count	80	80				
Pin Type 2: Row 2						
Average	30.85	1.31				
St. Dev.	1.49	1.65				
Min	25.10	0.00				
Max	34.13	8.17				
Summary Count	112	112				
Total Count	112	112				

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	≤ 5	$>5 \text{ & } \leq 10$	$>10 \text{ & } \leq 15$	$>15 \text{ & } \leq 50$	$>50 \text{ & } \leq 1000$	>1000
Acid Vapor	183	9	0	0	0	0

DATA SUMMARIES Continued

LLCR Shock & Vibration:

- 1). A total of 88 row1 and 104 row2 points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms: ----- Stable
 - b. $+5.1$ to $+10.0$ mOhms: ----- Minor
 - c. $+10.1$ to $+15.0$ mOhms: ----- Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: ----- Marginal
 - e. $+50.1$ to $+2000$ mOhms ----- Unstable
 - f. $>+2000$ mOhms: ----- Open Failure

MEC5-080-01-L-RA-WT2/0.056"EDGE CARD

		LLCR Measurement Summaries by Pin Type			
.056 Edge Card	Date	4/11/2017	5/2/2017		
	Room Temp (Deg C)	21	22		
	Rel Humidity (%)	41	33		
	Technician	Aaron McKim	Aaron McKim		
	mOhm values	Actual Initial	Delta Shock-Vib	Delta	Delta
		Pin Type 1: Row 1			
	Average	26.90	0.43		
	St. Dev.	1.29	0.31		
	Min	24.92	0.02		
	Max	34.71	1.19		
Summary Count	Summary Count	88	88		
	Total Count	88	88		
		Pin Type 2: Row 2			
	Average	31.20	0.40		
	St. Dev.	0.93	0.35		
Summary Count	Min	30.00	0.00		
	Max	34.84	1.69		
	Summary Count	103	103		
	Total Count	103	103		

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	≤ 5	$>5 \text{ & } \leq 10$	$>10 \text{ & } \leq 15$	$>15 \text{ & } \leq 50$	$>50 \text{ & } \leq 1000$	>1000
Shock-Vib	191	0	0	0	0	0

Nanosecond Event Detection:

Shock and Vibration Event Detection Summary						
Contacts tested	60					
Test Condition	C, 100g's, 6ms, Half-Sine					
Shock Events	0					
Test Condition	V-B, 7.56 rms g					
Vibration Events	0					
Total Events	0					

DATA SUMMARIES Continued

MEC5-080-01-L-RA-WT2/0.068"EDGE CARD

		LLCR Measurement Summaries by Pin Type			
Date		4/11/2017	4/18/2017		
Room Temp (Deg C)		21	23		
Rel Humidity (%)		41	36		
Technician		Aaron McKim	Aaron McKim		
mOhm values		Actual Initial	Delta Shock-Vib	Delta	Delta
.068 Edge Card		Pin Type 1: Row 1			
Average		25.97	0.32		
St. Dev.		0.61	0.24		
Min		24.81	0.01		
Max		28.81	1.46		
Summary Count		88	88		
Total Count		88	88		
		Pin Type 2: Row 2			
Average		30.46	0.18		
St. Dev.		0.51	0.15		
Min		29.57	0.00		
Max		31.92	0.71		
Summary Count		104	104		
Total Count		104	104		

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Shock-Vib	192	0	0	0	0	0

Tracking Code: 1044440 Report Rev 1	Part #: MEC5-080-01-L-RA-WT2 /EDGE CARD
	Part description: MEC5/EDGE CARD

EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: HZ-TCT-01

Description: Normal force analyzer

Manufacturer: Mecmesin Multitester

Model: Mecmesin Multitester 2.5-i

Serial #: 08-1049-04

Accuracy: Last Cal: 4/26/2016, Next Cal: 4/25/2017

Equipment #: HZ-OV-01

Description: Oven

Manufacturer: Huida

Model: CS101-1E

Serial #: CS101-1E-B

Accuracy: Last Cal: 12/13/2016, Next Cal: 12/12/2017

Equipment #: HZ-THC-01

Description: Humidity transmitter

Manufacturer: Thermtron

Model: SM-8-8200

Serial #: 38846

Accuracy: Last Cal: 2/28/2016, Next Cal: 2/27/2017

Equipment #: HZ-TSC-01

Description: Vertical Thermal Shock Chamber

Manufacturer: Cincinnati Sub Zero

Model: VTS-3-6-6-SC/AC

Serial #: 10-VT14994

Accuracy: See Manual

... Last Cal: 06/28/2016, Next Cal: 06/27/2017

Equipment #: HZ-HPM-01

Description: NA9636H

Manufacturer: Ainuo

Model: 6031A

Serial #: 089601091

Accuracy: Last Cal: 3/7/2016, Next Cal: 3/6/2017

Equipment #: HZ-MO-05

Description: Micro-ohmmeter

Manufacturer: Keithley

Model: 3706

Serial #: 1285188

Accuracy: Last Cal: 11/15/2016, Next Cal: 11/14/2017

Tracking Code: 1044440 Report Rev 1	Part #: MEC5-080-01-L-RA-WT2 /EDGE CARD
	Part description: MEC5/EDGE CARD

EQUIPMENT AND CALIBRATION SCHEDULES Continued

Equipment #: HZ-MO-01

Description: Micro-ohmmeter

Manufacturer: Keithley

Model: 2700

Serial #: 1199807

Accuracy: Last Cal: 04/28/2016, Next Cal: 04/28/2017

Equipment #: HZ-PS-01

Description: Power Supply

Manufacturer: Agilent

Model: 6031A

Serial #: MY41000982

Accuracy: Last Cal: 04/28/2016, Next Cal: 04/28/2017

Equipment #: ACLM-01

Description: Accelerometer

Manufacturer: PCB Piezotronics

Model: 352C03

Serial #: 115819

Accuracy: See Manual

... Last Cal: 07/18/2016, Next Cal: 07/18/2017

Equipment #: ED-03

Description: Event Detector

Manufacturer: Analysis Tech

Model: 32EHD

Serial #: 1100604

Accuracy: See Manual

... Last Cal: 10/31/2016, Next Cal: 10/31/2017

Equipment #: MO-04

Description: Multimeter /Data Acquisition System

Manufacturer: Keithley

Model: 2700

Serial #: 0798688

Accuracy: See Manual

... Last Cal: 09/11/2016, Next Cal: 09/11/2017